

GM5ZV03200Z Series

Chip LED

Through hole Type Large Current Drive Chip LED

Features

- (1) Super-luminosity chip LED
- (2) Using a package with high heat dissipation properties, it can be driven with a large current.
- (3) Wide viewing angle (2θ 1/2): 120°
- (4) Outline dimensions (resin portion) : $6.0 \times 5.0 \times 2.3$ mm
- (5) Applicable to soldering dip for through hole (with lead)

Applications

- (1) Amusement equipment
- (2) Information boards

Absolute Maximum Ratings

($T_a=25^\circ\text{C}$)

Model No.	Emitting color	Material	Power dissipation P (mW)	Forward current I_F (mA)	Peak forward current I_{FM}^{*1} (mA)	Derating factor (mA/ $^\circ\text{C}$)		Reverse voltage V_R (V)	Operating temperature T_{opr} ($^\circ\text{C}$)	Storage temperature T_{stg} ($^\circ\text{C}$)	Soldering temperature T_{sol}^{*2} ($^\circ\text{C}$)
						DC	Pulse				
GM5ZR03200Z	Red	AlGaInP on GaAs	200	70	80	0.93	1.07	5	-30 to +85	-40 to +100	295
GM5ZJ03200Z	Orange	AlGaInP on GaAs	200	70	80	0.93	1.07	5	-30 to +85	-40 to +100	295
GM5ZS03200Z	Sunset-orange	AlGaInP on GaAs	200	70	80	0.93	1.07	5	-30 to +85	-40 to +100	295
GM5ZV03200Z	Amber	AlGaInP on GaAs	200	70	80	0.93	1.07	5	-30 to +85	-40 to +100	295
GM5GC03200Z	Green	InGaP	240	50	60	0.40	0.67	5	-30 to +85	-40 to +100	295
GM5BC03200Z	Blue	InGaP	240	50	60	0.40	0.67	5	-30 to +85	-40 to +100	295

*1 Duty ratio=1/10, Pulse width=0.1ms

*2 For 3s or less at the temperature of hand soldering.

Electro-optical Characteristics

($I_F=60$ mA (Blue, Green: $I_F=50$ mA), $T_a=25^\circ\text{C}$)

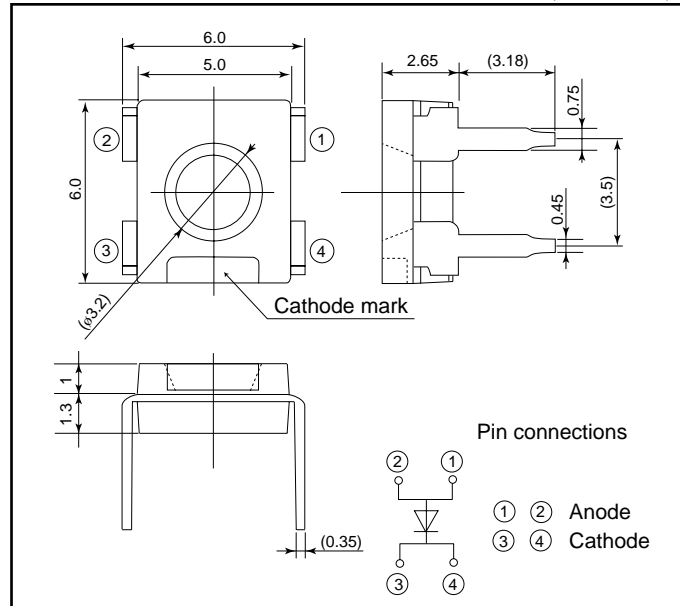
Lens type	Model No.	Forward voltage V_F (V)		Peak emission wavelength λ_p (nm) TYP	Dominant wavelength λ_d (nm) TYP	Luminous intensity I_v (mcd) TYP	Spectrum radiation bandwidth $\Delta\lambda$ (nm) TYP	Reverse current	
		TYP	MAX					I_R (μA) MAX	V_R (V)
Colorless transparency	GM5ZR03200Z	2.2	2.9	647	635	400	18	100	4
	GM5ZJ03200Z	2.2	2.9	627	618	500	18	100	4
	GM5ZS03200Z	2.2	2.9	609	605	700	18	100	4
	GM5ZV03200Z	2.2	2.9	591	588	500	18	100	4
	GM5GC03200Z	4.4	5.5	513	519	520	36	100	4
	GM5BC03200Z	4.6	5.5	467	470	200	27	100	4

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Outline Dimensions

(Unit : mm)



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- Personal computers
- Office automation equipment
- Telecommunication equipment [terminal]
- Test and measurement equipment
- Industrial control
- Audio visual equipment
- Consumer electronics

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- Transportation control and safety equipment (i.e., aircraft, trains, automobiles, etc.)
- Traffic signals
- Gas leakage sensor breakers
- Alarm equipment
- Various safety devices, etc.

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- Space applications
- Telecommunication equipment [trunk lines]
- Nuclear power control equipment
- Medical and other life support equipment (e.g., scuba).

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